

GSEPN12B0005

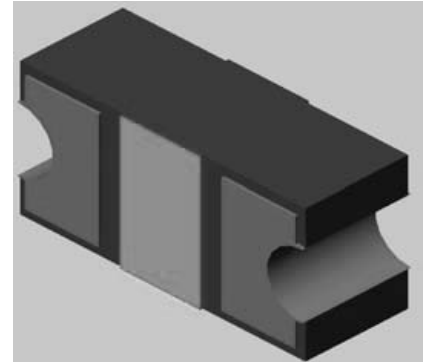
Multilayer Polymer ESD Suppressor

Description

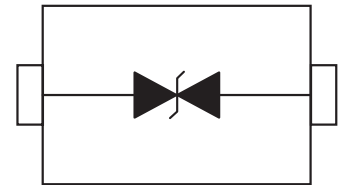
The GSEPN12B0005 is an ultra low capacitance polymer ESD suppressor designed to protect high speed data interfaces. The device has a typical capacitance of only 0.05pf (I/O to GND) and meets the ESD immunity requirements of IEC61000-4-2 (15KV air, 8KV contact discharge).

Features

- ESD protection for high speed data lines to IEC61000-4-2
- ESD contact discharge typical 8KV, max 15KV
- ESD air discharge typical 15KV, max 25KV
- Multilayer structure
- Surface mount
- Extremely low capacitance
- Very Low leakage current
- Fast response time
- Bi-directional ESD protection
- Lead free solder termination
- The Best ESD protection for high frequency, low voltage applications



Case: 0603



Schematic Diagram

Applications

- High Definition Multi-Media Interface (HDMI)
- Digital Visual Interface (DVI)
- Display Port Interface (DP)
- Unified Display Interface (UDI)
- Mobile Display Digital Interface (MDDI)
- Gigabit Ethernet
- USB2.0 and USB3.0
- IEEE1394 Interface

Absolute Maximum Ratings

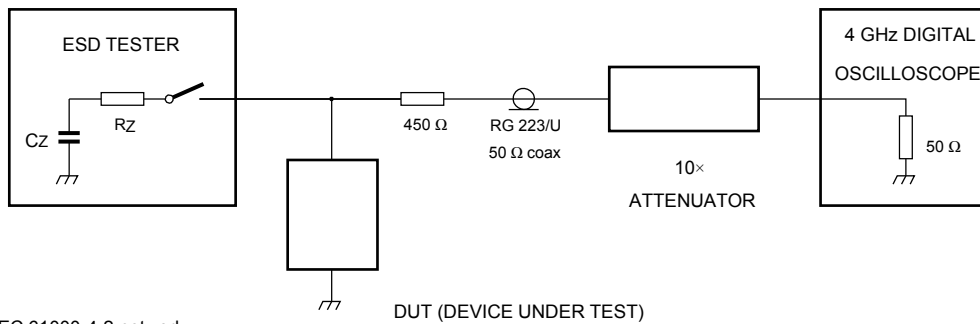
Parameter	Symbol	Value	Unit
Maximum Contact Discharge Voltage Per IEC61000-4-2	-	15KV	V
Maximum Air Discharge Voltage Per IEC61000-4-2	-	25KV	V
Maximum Operating Temperature	T _{OPER}	-55 to +125	°C
Maximum Storage Temperature	T _{STG}	-55 to +125	°C
Maximum Lead Temperature for Soldering During 10s	T _L	260	°C

Electrical Characteristics ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Rated Voltage	V_R	-	-	-	12	V
Trigger Voltage	V_T	IEC61000-4-2 8KV contact discharge	-	300	-	V
Clamping Voltage	V_C	IEC61000-4-2 8KV contact discharge	-	35	-	V
Leakage Current	I_L	DC 12V shall be applied on component	-	0.01	0.1	μA
Capacitance	C_P	$V_R = 0\text{V}$, $f = 1\text{MHz}$	-	0.05	-	pF

- Notes:
1. Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.
 2. After reliability tests such as high Temp storage, Temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.

ESD Clamping Test



IEC 61000-4-2 network
 $C_Z = 150\ \text{pF}$; $R_Z = 330\ \Omega$

ESD Clamping Test Waveforms

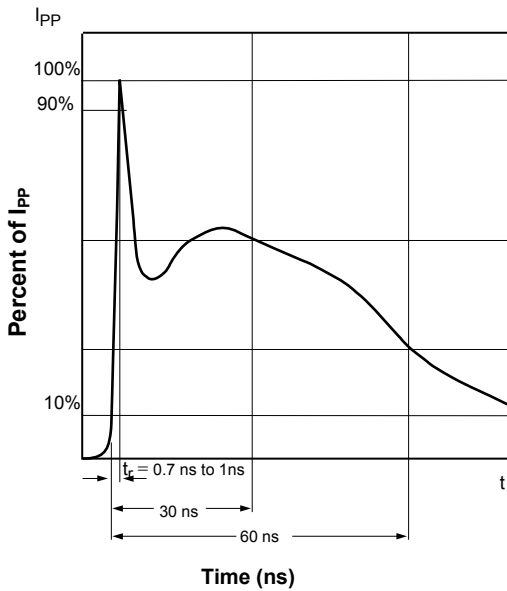


Fig.1 Pulse Waveform-ESD(IEC61000-4-2)

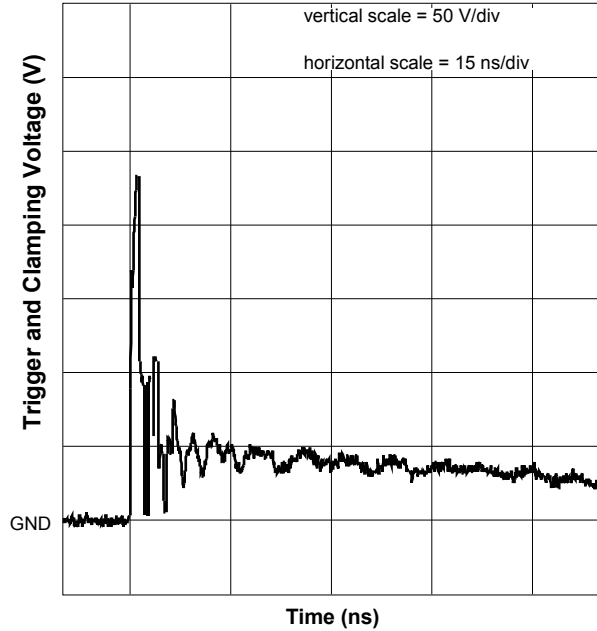
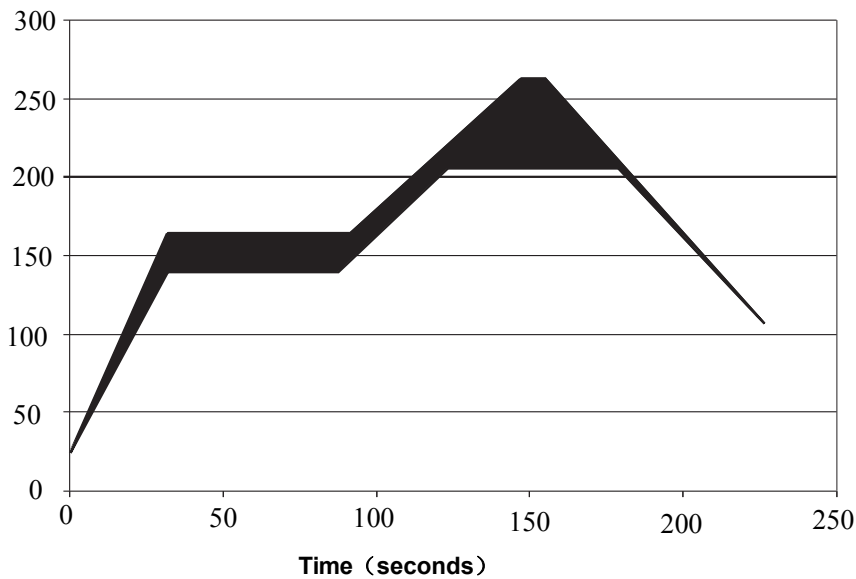


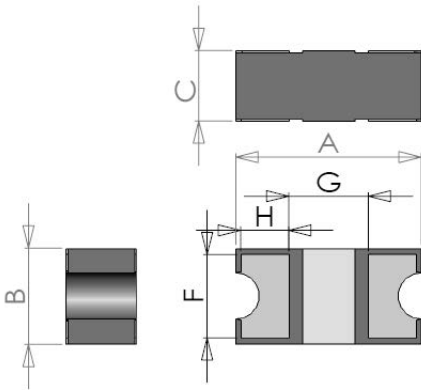
Fig.2 IEC61000-4-2 +8kV Contact Discharge

Solder Reflow Recommendations

Temperatures (°C)

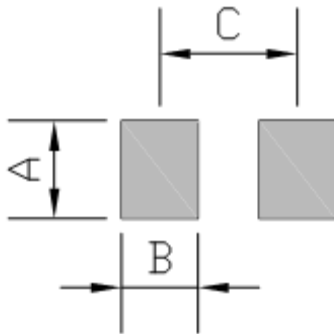


Package Outline Dimensions



Symbol	Dimension			Unit
	Min	Typ	Max	
A	1.50	1.60	1.70	mm
B	0.74	0.82	0.90	
C	0.32	0.36	0.40	
H	0.265	0.285	0.305	
F	0.70	0.72	0.74	
G	0.93	0.95	0.97	

Suggested Pad Layout



Symbol	Dimension	Unit
A	0.95	mm
B	0.65	
C	1.35	

Order Information

Device	Package	Net Weight	Carrier	Quantity	HSF Status
GSEPN12B0005	0603	1.00 mg	Tape & Reel	3,000pcs/reel	RoHS compliant